PIC32MZ Embedded Connectivity (EC) Starter Kit User's Guide

QUALITY MANAGEMENT SYSTEM

CERTIFIED BY DNV

═ **ISO/TS 16949** ═

Object of Declaration:

PIC32MZ Embedded Connectivity (EC) Starter Kit (DM320006, DM320006-C)

EU Declaration of Conformity

Manufacturer: Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, Arizona, 85224-6199
USA

This declaration of conformity is issued by the manufacturer.

The development/evaluation tool is designed to be used for research and development in a laboratory environment. This development/evaluation tool is not a Finished Appliance, nor is it intended for incorporation into Finished Appliances that are made commercially available as single functional units to end users under EU EMC Directive 2004/108/EC and as supported by the European Commission's Guide for the EMC Directive 2004/108/EC (8th February 2010).

This development/evaluation tool complies with EU RoHS2 Directive 2011/65/EU.

This development/evaluation tool, when incorporating wireless and radio-telecom functionality, is in compliance with the essential requirement and other relevant provisions of the R&TTE Directive 1999/5/EC and the FCC rules as stated in the declaration of conformity provided in the module datasheet and the module product page available at www.microchip.com.

For information regarding the exclusive, limited warranties applicable to Microchip products, please see Microchip's standard terms and conditions of sale, which are printed on our sales documentation and available at www.microchip.com.

Signed for and on behalf of Microchip Technology Inc. at Chandler, Arizona, USA

Derek Carlson

Derek Carlson
VP Development Tools

12-Sep-14
Date

NOTES:

PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT USER'S GUIDE

Table of Contents

NOTES:

PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT USER'S GUIDE

Preface

NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a "DS" number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is "DSXXXXXXXXA", where "XXXXXXXX" is the document number and "A" is the revision level of the document.

For the most up-to-date information on development tools, see the MPLAB® IDE online help. Select the Help menu, and then Topics to open a list of available online help files.

INTRODUCTION

This chapter contains general information that will be useful to know before using the PIC32MZ Embedded Connectivity (EC) Starter Kit. Items discussed in this chapter include:

- Document Layout
- Conventions Used in this Guide
- Recommended Reading
- The Microchip Web Site
- Development Systems Customer Change Notification Service
- Customer Support
- Document Revision History

DOCUMENT LAYOUT

This document describes how to use the PIC32MZ Embedded Connectivity (EC) Starter Kit (also referred to as "starter kit") as a development tool to emulate and debug firmware on a target board. This user's guide is composed of the following chapters:

- **Chapter 1. "Introduction"** provides a brief overview of the starter kit, highlighting its features and functionality.
- **Chapter 2. "Hardware"** provides the hardware descriptions of the starter kit.
- **Appendix A. "Schematics"** provides a block diagram, board layouts, and detailed schematics of the starter kit.
- **Appendix B. "Bill of Materials"** provides the bill of materials for the components used in the design and manufacture of the starter kit.

CONVENTIONS USED IN THIS GUIDE

This manual uses the following documentation conventions:

DOCUMENTATION CONVENTIONS

Description	Represents	Examples
Italic characters	Referenced books	*MPLAB IDE User's Guide*
	Emphasized text	...is the *only* compiler...
Initial caps	A window	the Output window
	A dialog	the Settings dialog
	A menu selection	select Enable Programmer
Quotes	A field name in a window or dialog	"Save project before build"
Underlined, italic text with right angle bracket	A menu path	*File>Save*
Bold characters	A dialog button	Click **OK**
	A tab	Click the **Power** tab
Text in angle brackets < >	A key on the keyboard	Press <Enter>, <F1>
`Plain Courier New`	Sample source code	`#define START`
	Filenames	`autoexec.bat`
	File paths	`c:\mcc18\h`
	Keywords	`_asm, _endasm, static`
	Command-line options	`-Opa+, -Opa-`
	Bit values	`0, 1`
	Constants	`0xFF, 'A'`
`Italic Courier New`	A variable argument	`file`.o, where `file` can be any valid filename
Square brackets [ ]	Optional arguments	`mcc18 [options] file [options]`
Curly brackets and pipe character: {|}	Choice of mutually exclusive arguments; an OR selection	`errorlevel {0|1}`
Ellipses...	Replaces repeated text	`var_name [, var_name...]`

	Represents code supplied by user	`void main (void)`
		`{ ...`
		`}`

Notes	A Note presents information that we want to re-emphasize, either to help you avoid a common pitfall or to make you aware of operating differences between some device family members. A Note can be in a box, or when used in a table or figure, it is located at the bottom of the table or figure.	**Note:** This is a standard note box. **CAUTION** **This is a caution note.** **Note 1:** This is a note used in a table.

RECOMMENDED READING

This user's guide describes how to use the starter kit. The following Microchip documents are available and recommended as supplemental reference resources.

PIC32MZ Embedded Connectivity (EC) Family Data Sheet (DS60001191)

Refer to this document for detailed information on PIC32MZ EC family devices. Reference information found in this data sheet includes:

- Device memory maps
- Device pinout and packaging details
- Device electrical specifications
- List of peripherals included on the devices

MPLAB® XC32 C/C++ Compiler User's Guide (DS50001686)

This document details the use of Microchip's MPLAB XC32 C/C++ Compiler to develop an application.

MPLAB® X IDE User's Guide (DS50002027)

Refer to this document for more information pertaining to the installation and implementation of the MPLAB X IDE software, as well as the MPLAB SIM Simulator software that is included with it.

Universal Serial Bus Specification and Associated Documents

The Universal Serial Bus is defined by the USB 2.0 specification and its associated supplements and class-specific documents. These documents are available from the USB Implementers Forum. See their web site at: http://www.usb.org

THE MICROCHIP WEB SITE

Microchip provides online support via our web site at http://www.microchip.com. This web site makes files and information easily available to customers. Accessible by most Internet browsers, the web site contains the following information:

- **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** – Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip consultant program member listings
- **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listings of seminars and events; and listings of Microchip sales offices, distributors and factory representatives

DEVELOPMENT SYSTEMS CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com, click on Customer Change Notification and follow the registration instructions.

The Development Systems product group categories are:

- **Compilers** – The latest information on Microchip C compilers and other language tools
- **Emulators** – The latest information on the Microchip in-circuit emulator, MPLAB REAL ICE™
- **In-Circuit Debuggers** – The latest information on the Microchip in-circuit debugger, MPLAB ICD 3
- **MPLAB X IDE** – The latest information on Microchip MPLAB X IDE, the Windows® Integrated Development Environment for development systems tools
- **Programmers** – The latest information on Microchip programmers including the PICkit™ 3 development programmer

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

DOCUMENT REVISION HISTORY

Revision A (November 2013)

This is the initial release of this document.

Revision B (February 2014)

The following sections were updated to reflect the LAN8740 PHY Daughter Board, which is included in the starter kit:

- **1.1 "Kit Contents"**
- **1.2 "Starter Kit Functionality and Features"**
- **2.1.9 "Ethernet PHY"**
- **Appendix A. "Schematics"**
- **Appendix B. "Bill of Materials"**

Revision C (March 2016)

This revision includes the following updates:

- The EU Declaration of Conformity was added (see Object of Declaration:)
- The Ethernet PHY Daughter Board in the starter kit has been updated to the LAN8740A:
  - **1.1 "Kit Contents"**
  - **1.2.2 "LAN8740A PHY Daughter Board"**
  - **2.1.9 "Ethernet PHY"**
  - **Figure A-6: "LAN8740A PHY Daughter Board Schematics"**
  - **B.2 "LAN8740A PHY Daughter Board Bill of Materials"**
- The SQI memory size listed in item 12 of **1.2.1 "Development Board"** was changed to 4 MB
- Updates to component references were implemented throughout the **2.1 "Hardware Features"** section
- **Figure A-1: "High-Level Block Diagram of the PIC32MZ Embedded Connectivity (EC) Starter Kit"** was updated

NOTES:

Chapter 1. Introduction

Thank you for purchasing a Microchip Technology PIC32MZ Embedded Connectivity (EC) Starter Kit. This starter kit provides a low-cost, modular development system for Microchip's line of 32-bit microcontrollers.

Two versions of the starter kit are available:

- PIC32MZ Embedded Connectivity Starter Kit (DM320006)
- PIC32MZ Embedded Connectivity Starter Kit w/Crypto Engine (DM320006-C)

Both versions of the starter kit are preloaded with demonstration software that can be used to explore the new features of the PIC32MZ EC family of devices. It is also expandable through a modular expansion interface, which allows the user to extend its functionality. The starter kit also supplies on-board circuitry for full debug and programming capabilities.

This chapter covers the following topics:

- Kit Contents
- Starter Kit Functionality and Features

The preprogrammed example code on the PIC32MZ EC family MCU is available for download from the Microchip web site at http://www.microchip.com. All project files have been included so that the code may be used directly to restore the PIC32MZ EC family MCU on the starter kit to its original state (i.e., if the sample device has been reprogrammed with another program) or so you can use the tutorial code as a platform for further experimentation.

1.1 KIT CONTENTS

The PIC32MZ Embedded Connectivity (EC) Starter Kit contains the following items:

- PIC32MZ Embedded Connectivity (EC) Starter Kit Development Board
- LAN8740A Ethernet PHY Daughter Board
- USB mini-B to full-sized A cable – USB debug cable to debug and power the Development Board
- USB micro-B to full-sized A cable – PIC32 USB cable to communicate with the PIC32 USB port
- RJ-45 CAT5 Ethernet patch cable – Ethernet CAT5 cable to communicate with the PIC32 Ethernet port

> **Note:** If you are missing any part of a kit, contact a Microchip sales office for assistance. A list of Microchip offices for sales and service is provided on the back page of this document.

1.2   STARTER KIT FUNCTIONALITY AND FEATURES

1.2.1   Development Board

Representations of the layout of the development board included in the PIC32MZ Embedded Connectivity (EC) Starter Kit are shown in Figure 1-1 and Figure 1-2.

The top assembly of the board includes these key features, as indicated in Figure 1-1:

1. PIC32MZ2048ECH144-I/PH or PIC32MZ2048ECM144-I/PH (Crypto Engine) 32-bit microcontroller.
2. Green power indicator LED.
3. On-board crystal or oscillator for precision microcontroller clocking (24 MHz).
4. USB connectivity for on-board debugger communications.
5. Green debug indicator LED.
6. Three push button switches for user-defined inputs.
7. Three user-defined indicator LEDs.
8. USB Type A receptacle connectivity for PIC32 host-based applications.
9. HOST mode power jumper.
10. Daughter board connectors for flexible Ethernet PHY options.
11. 32 kHz oscillator for RTCC and Timer1 (optional).
12. External 4 MB SQI memory for expanded memory applications.
13. Jumper for using or disconnecting the on-board debugger.

> **Note:**   When running self-powered USB device applications, open the jumper JP1 to prevent possibly back-feeding voltage onto the V$_{BUS}$ from one port on the host to another (or from one host to another).

For more information on key features, refer to **Chapter 2. "Hardware"**.

FIGURE 1-1:   **PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT LAYOUT (TOP VIEW)**

Introduction
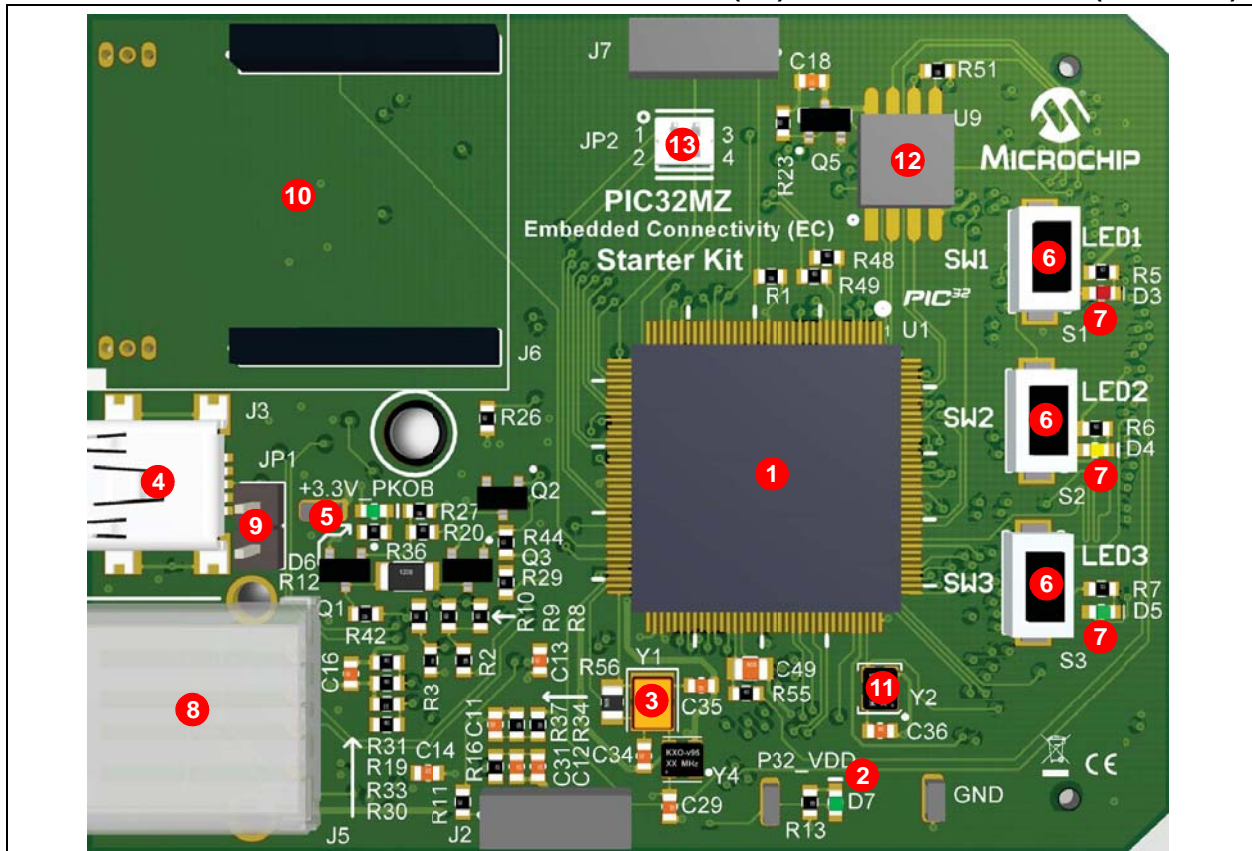
The bottom assembly of the board includes these key features, as indicated in Figure 1-2:

1. PIC24FJ256GB106 USB microcontroller for on-board debugging.
2. Regulated +3.3V power supply for powering the starter kit through USB or expansion board.
3. Connector for various expansion boards.
4. USB Type micro-AB receptacle for OTG and USB device connectivity for PIC32 OTG/device-based applications.
5. 50 MHz Ethernet PHY oscillator.
6. USB Host and OTG power supply for powering PIC32 USB applications.

FIGURE 1-2:   PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT LAYOUT (BOTTOM VIEW)
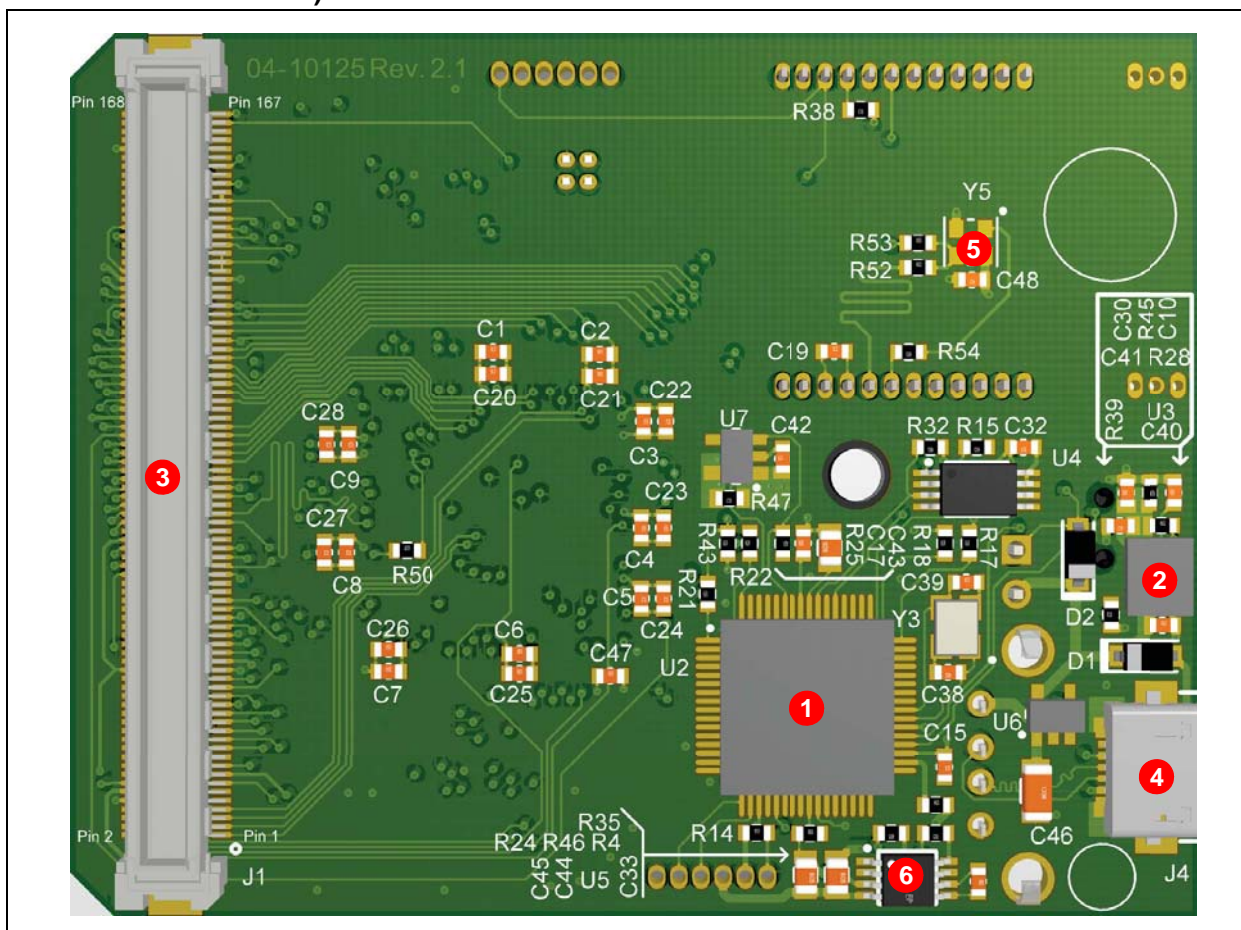
1.2.2   LAN8740A PHY Daughter Board

Representation of the layout of the daughter board included in the PIC32MZ Embedded Connectivity (EC) Starter Kit is shown in Figure 1-3 and Figure 1-4.

**FIGURE 1-3:   DAUGHTER BOARD LAYOUT (TOP VIEW)**
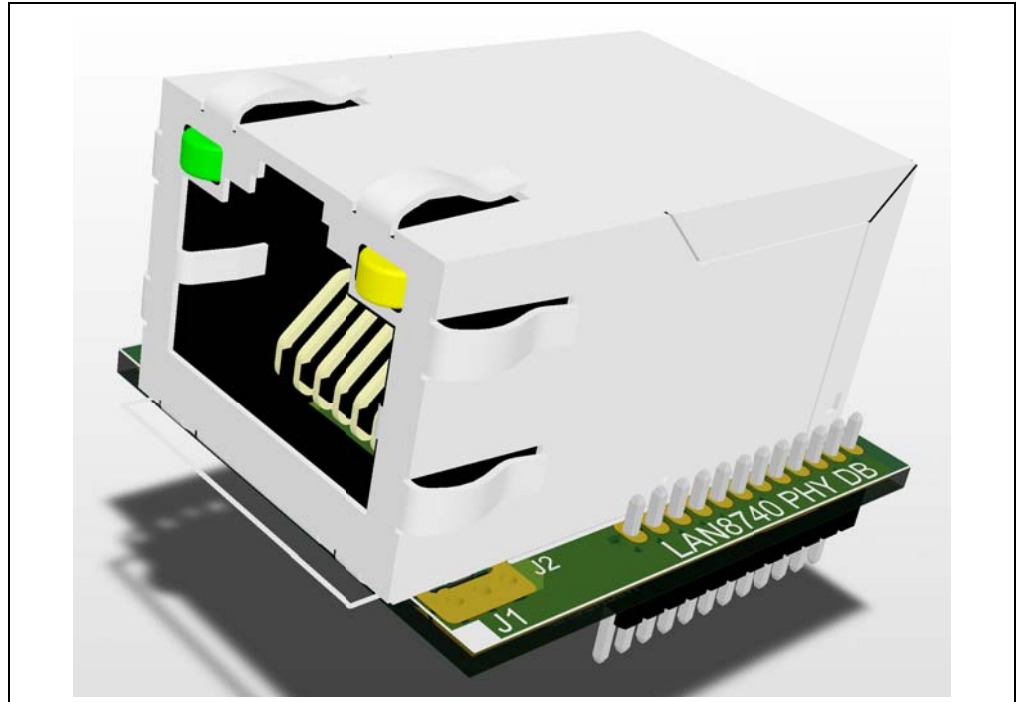
FIGURE 1-4:   DAUGHTER BOARD LAYOUT (BOTTOM VIEW)
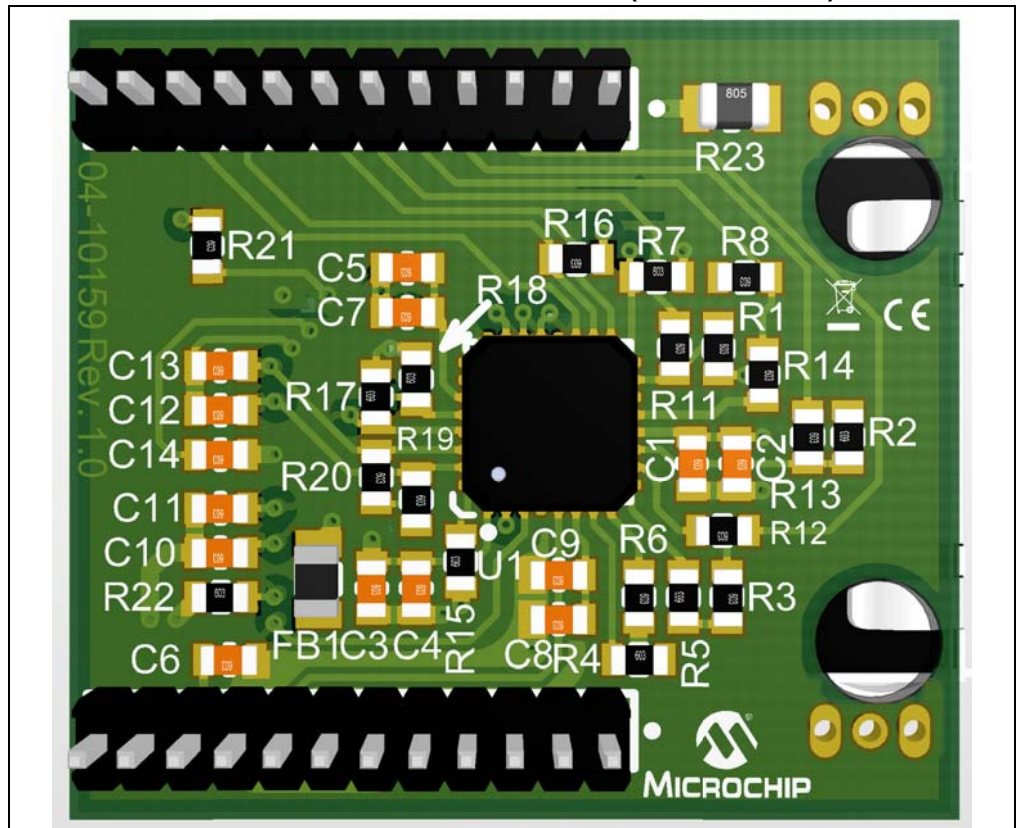
Chapter 2. Hardware

This chapter describes the hardware features of the PIC32MZ Embedded Connectivity (EC) Starter Kit.

2.1 HARDWARE FEATURES

The following key features of the starter kit are presented in the order given in **Section 1.2 "Starter Kit Functionality and Features"**. Refer to Figure 1-1 for their locations on the development board.

2.1.1 Processor Support

Depending on the starter kit purchased, the development board is designed with a permanently mounted (i.e., soldered) processor, which is either the PIC32MZ2048ECM144 (Crypto Engine) or the PIC32MZ2048ECH144 (without Crypto Engine).

2.1.2 Power Supply

There are two ways to supply power to the starter kit:

• USB bus power is connected to the USB debug connector J3
• An external application board with a regulated DC power supply that provides +5V can be connected to the J1 application board connector that is provided on the bottom side of the board

One green LED (D7) is provided to indicate the PIC32 device is powered up.

2.1.3 Debug USB Connectivity

The starter kit includes a PIC24FJ256GB106 USB microcontroller that provides debugger connectivity over USB. The PIC24FJ256GB106 is hard-wired to the PIC32 device to provide protocol translation through the I/O pins of the PIC24FJ256GB106 to the ICSP™ pins of the PIC32 device.

If MPLAB® REAL ICE™ or MPLAB ICD 3 is used with the starter kit, disconnect the on-board debugger from the PIC32 device by removing the jumper JP2. When the on-board debugger is required, replace the jumper JP2. When the jumper JP2 is installed, pin 1 must be connected to pin 3 and pin 2 must be connected to pin 4.

2.1.4 PIC32 USB Connectivity

There are three possible ways to connect to the PIC32 USB microcontroller:

• HOST Mode – Connect the device to the Type A connector J5, which is located on the top of the starter kit. If using the Debug USB port to power the Host port, install the jumper JP1 to short the back-power prevention diode. Note that a maximum of ~400 mA can be supplied from the Debug USB port to the Host port using this method. If the full 500 mA supply is needed, an external supply must be connected to the application board and jumper JP1 must be removed to prevent back-powering the Debug USB port.

- DEVICE Mode – Connect the debug mini-B USB cable to port J3 and then connect the starter kit to the host by using a cable with a Type-B micro-connector to the starter kit's micro-A/B port J4, which is located on the bottom of the board. The other end of the cable must have a Type-A connector. Connect the Type-A connector to a USB host. Jumper JP1 should be removed.

- OTG Mode – Connect the starter kit to the OTG device using an OTG micro-A/B cable to the micro-A/B port J4, which is located on the bottom side of the board. The starter kit provides an on-board power supply capable of providing 120 mA Max. This supply is controlled by the PIC32MZ2048ECH144 device. Jumper JP1 should be removed.

2.1.5   Switches

Push button switches provide the following functionality:

- SW1: Active-low switch connected to RB12
- SW2: Active-low switch connected to RB13
- SW3: Active-low switch connected to RB14

The switches do not have any debounce circuitry and require internal pull-up resistors; this enables the user to investigate software debounce techniques. When Idle, the switches are pulled high (+3.3V), and they are grounded when pressed.

2.1.6   LEDs

The LEDs, LED1 through LED3, are connected to PORTH (RH0 through RH2) of the processor. The PORTH pins are set high to illuminate the LEDs.

2.1.7   Oscillator Options

A 24 MHz oscillator circuit (Y4) is connected to the on-board microcontroller. This oscillator circuit functions as the controller's primary oscillator. Depending on which is populated on the starter kit board, a 24 MHz crystal (Y1) may be used instead of Y4.

Use of an external crystal or external oscillator is required to develop USB applications. The USB specification dictates a frequency tolerance of ±0.05% for high speed. Non-USB applications can use the internal oscillators.

The starter kit also has provisions for an external secondary 32 kHz oscillator (Y2); however, this is not populated. A suitable oscillator, the ECS-3X8, can be obtained from Digi-Key: P/N - X801-ND CMR200TB32.768KDZFTR.

The PIC24FJ256GB106 is independently clocked and has its own 12 MHz crystal.

2.1.8   168-pin Modular Expansion Connector

The PIC32MZ Embedded Connectivity (EC) Starter Kit is designed with a 168-pin modular expansion interface, which allows the board to provide basic generic functionality and easy extendability to new technologies as they become available.

TABLE 2-1:   STARTER KIT CONNECTOR PART NUMBERS

Connector	HIROSE Electric PN
Starter Kit Connector	FX10A-168P-SV1(71)
Application Board Connector	FX10A-168S-SV

2.1.9 Ethernet PHY

The Ethernet PHY Daughter Board included in the starter kit is populated with a low-power, small-footprint, 10/100 Fast Ethernet LAN8740A PHY, which features Energy Efficient Ethernet (IEEE 802.3az) and Wake-on-LAN functionality. This daughter board is designed for easy development of RMII Ethernet control applications when it is connected into a compatible PIC32 starter kit.

To use a different Ethernet PHY other than what is offered, visit the microchipDIRECT website (www.microchipdirect.com) for the list of alternate options.

NOTES:

Appendix A. Schematics

A.1 BLOCK DIAGRAM

FIGURE A-1: HIGH-LEVEL BLOCK DIAGRAM OF THE PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT
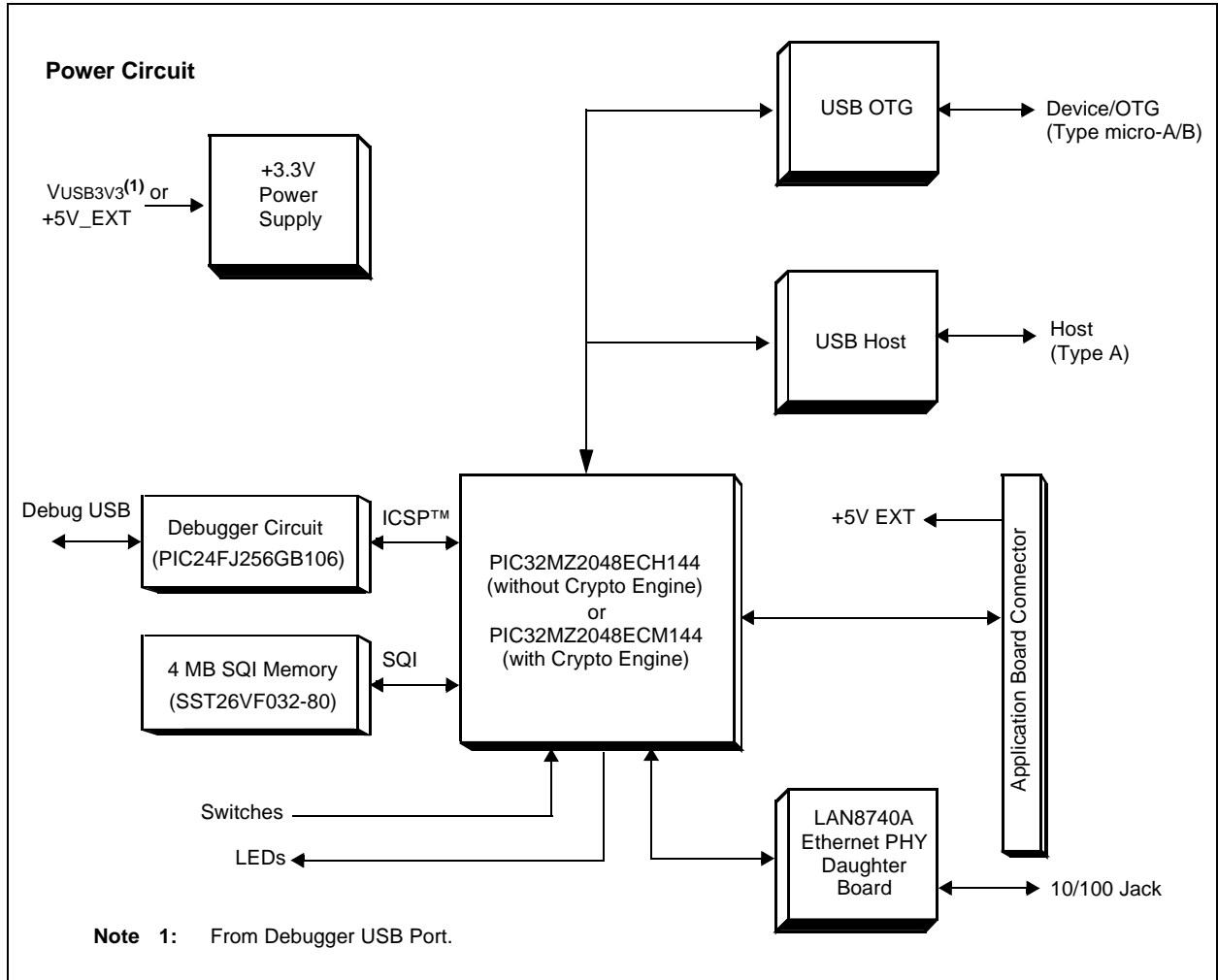
A.2 SCHEMATICS

FIGURE A-2: PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT (PIC32MZ EC FAMILY DEVICE)
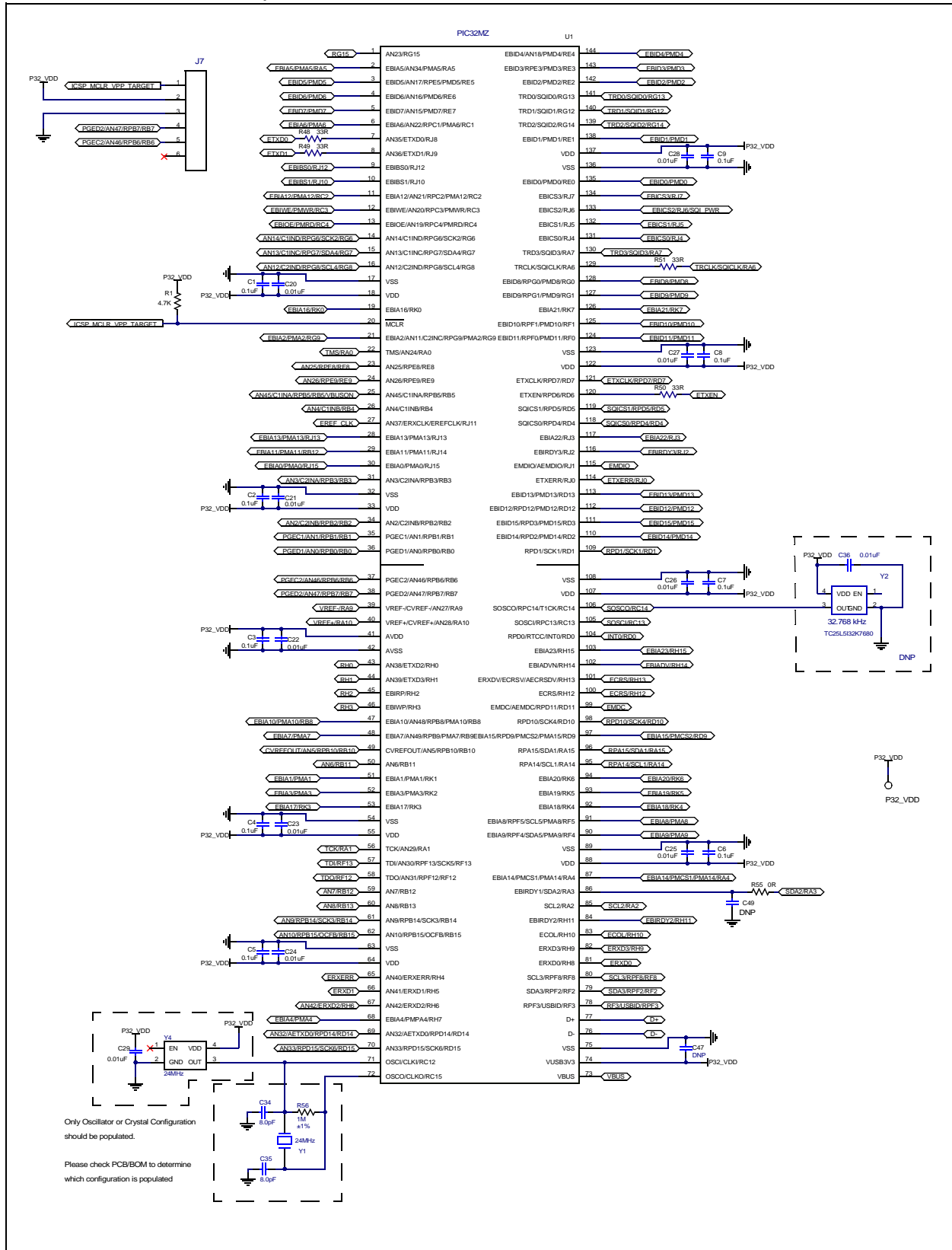
FIGURE A-3: **PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT (USB HOST AND OTG POWER SUPPLIES)**

PIC32MZ Embedded Connectivity (EC) Starter Kit User's Guide
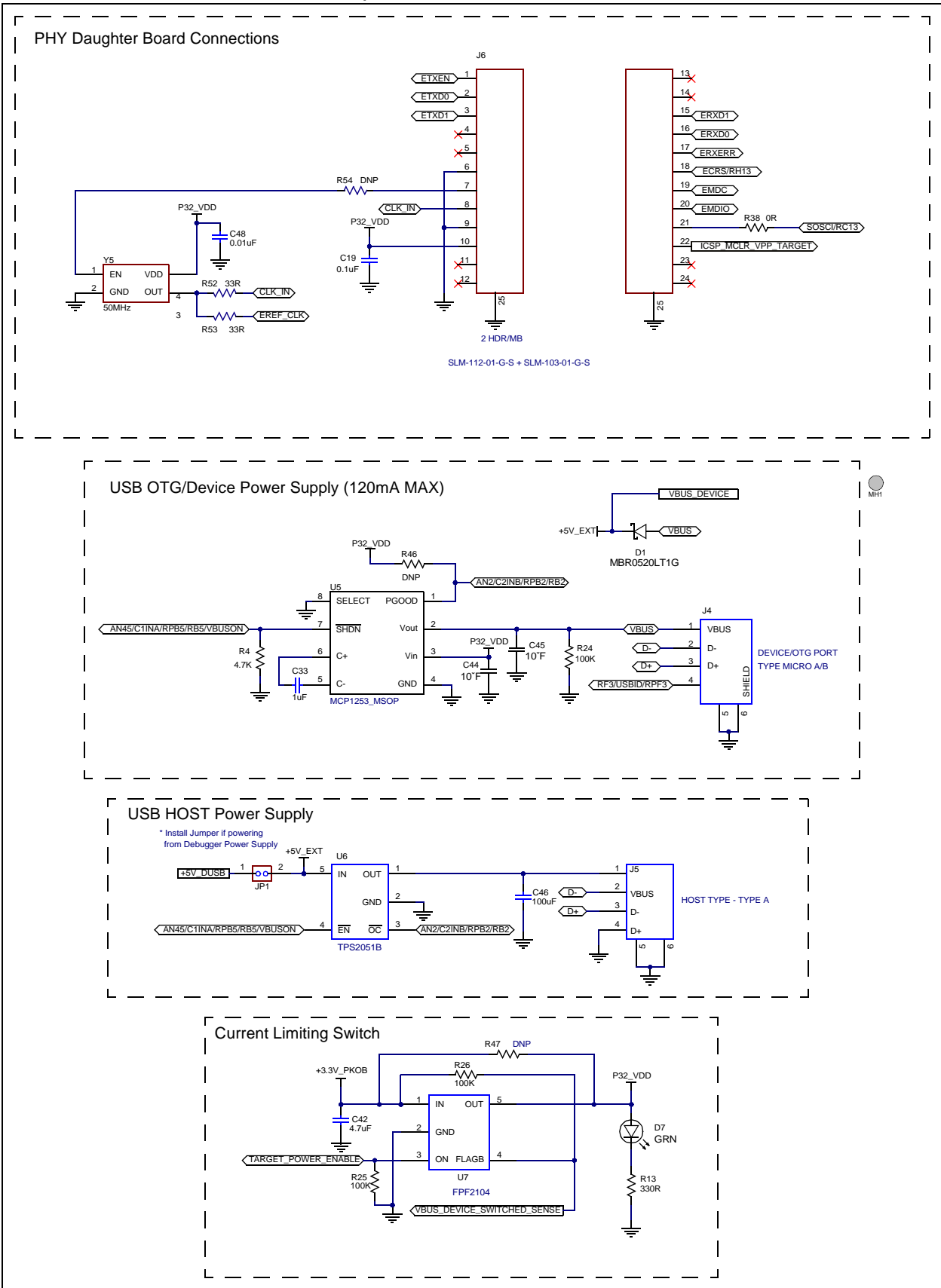
FIGURE A-4: PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT (DEBUGGER)

SERIAL EEPROM (25LC256)

+3.3V_PKOB

U4
25LC256-I/ST

R15 10K
R32 2.21K

UTIL SDO
UTIL SCK
UTIL CS
UTIL WP
UTIL SDI

C32 1uF
GND

(Local V_DD/V_SS bypass/decoupling)

+3.3V_PKOB
C13 0.1uF
C14 0.1uF
C15 0.1uF
C16 0.1uF
C17 0.1uF
GND

TARGET POWER ENABLE
+3.3V_PKOB
C43 10°F
GND

R29 200K
GND

VBUS DEVICE SWITCHED SENSE

UTIL WP
UTIL CS
SDO
SDI
SCK

PIC24FJ256GB106
U2

VPP_ON
VPP_GND

ICSP MCLR VPP PICKIT3
R11 330R

+3.3V_PKOB
GND

+3.3V_PKOB
R34 1K
VPP SENSE
VDD SENSE
VREF 2.5V
R37 3.16K
C11 0.1uF
GND

PGC PKOB
PGD PKOB
+3.3V_PKOB

R16 10K
C31 1uF
C12 0.1uF
GND

+3.3V_PKOB
GND

ASSEMBLY ID 1
R17 10K
ASSEMBLY ID 0
R18 10K
+3.3V_PKOB
GND

UTIL SDO
UTIL SDI

UTIL SCK
GND

C39 8pF
Y3 12.0MHz
C38 8pF
+3.3V_PKOB
GND

USB D+
USB D-
+3.3V_PKOB
R35 100R
VBUS DEVICE

POWER GOOD PICKIT3

+3.3V_PKOB
R14 10K
J2

ICSP MCLR VPP PICKIT3
PGD PKOB
PGC PKOB
GND

JP2 Jumper Positions

	PKOB Mode	REAL ICE Mode
pins 1-3: Shorted	pins 1-3: Open
pins 2-4: Shorted	pins 2-4: Open

TARGET ICSP SIGNALS

SDO
R8 330R
SDI
R9 330R
R2 4.7K
JP2
PGED2/AN47/RPB7/RB7
SCK
R10 330R
R3 4.7K
GND
PGEC2/AN46/RPB6/RB6

POWER DISTRIBUTION/SWITCHING

USB INTERFACE
(BUS POWERED)

J3
UX60-MB-5ST
+5V DUSB
USB D-
USB D+

D2
MBR0520LT1G
VBUS DEVICE
C40 2.2uF

U3
MCP1727-3302E/MF
+3.3V_PKOB
C41 2.2uF
C10 0.1uF
C30 0.01uF
R45 DNP 2.2K
R12 330R
D6 GRN

R28 200K

R39 0R
EGND
GND
GND
POWER_GOOD_PICKIT3

+3.3V_PKOB
R33 3.92K
R19 10K
R27 100K
VDD SENSE
VPP SENSE
R30 2.21K
R31 2.21K
R20 10K
GND

Q1 MMBT3906-TP
R42 0R
ICSP MCLR VPP TARGET
R36 100R 1206 1/4W

+3.3V_PKOB
GND
+3.3V DNP
VPP ON
R21 10K
Q2 MMBT3904-TP
R43 DNP

VPP GND
R22 10K
Q3 MMBT3904-TP
R44 DNP
GND

FIGURE A-5: **PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT (APPLICATION BOARD CONNECTOR, SQI MEMORY AND POWER, LEDS, AND SWITCHES)**

PIC32MZ Embedded Connectivity (EC) Starter Kit User's Guide

FIGURE A-6: **LAN8740A PHY DAUGHTER BOARD SCHEMATICS**

Appendix B. Bill of Materials

B.1   STARTER KIT BILL OF MATERIALS

TABLE B-1:   PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT BILL OF MATERIALS

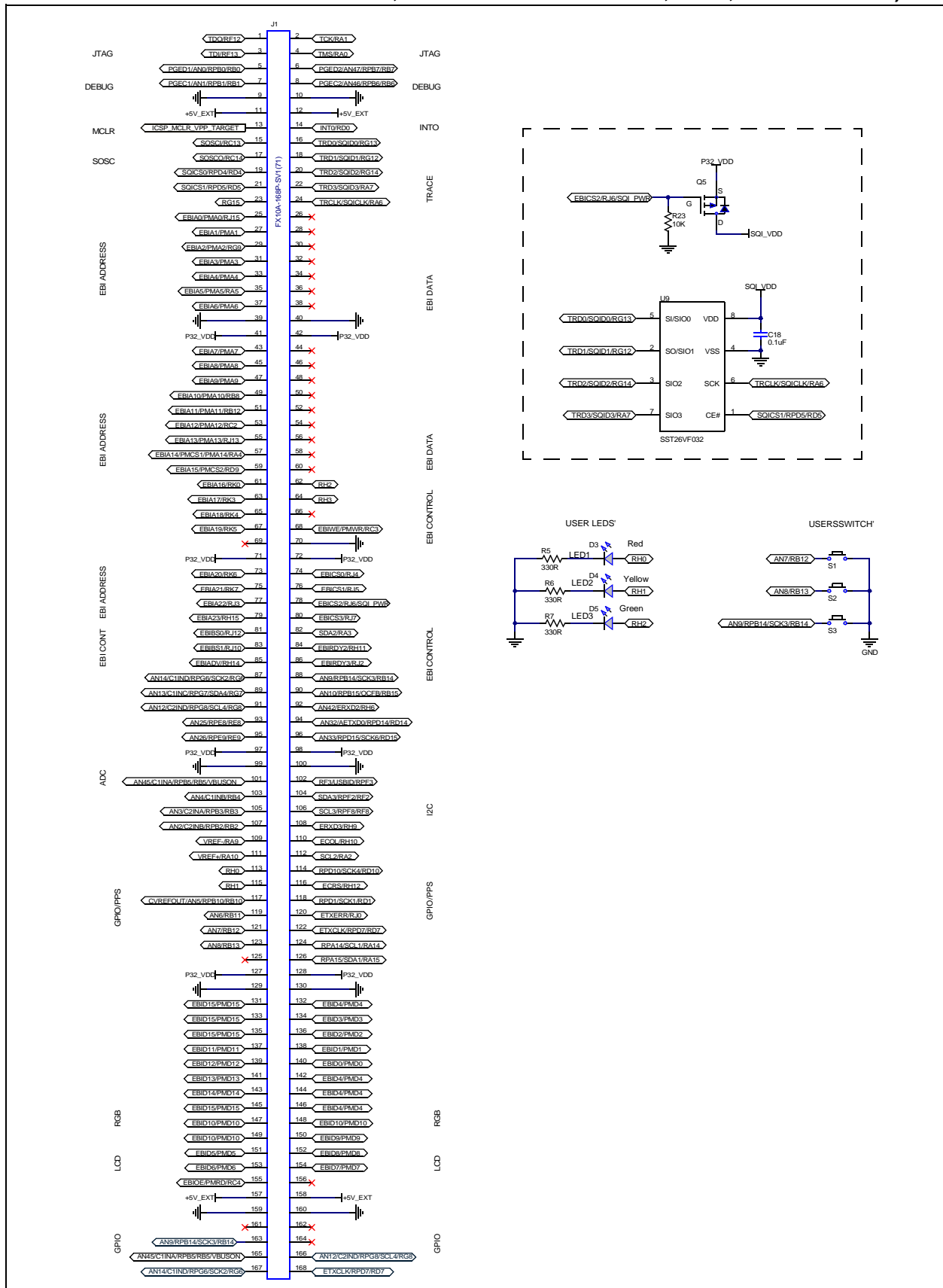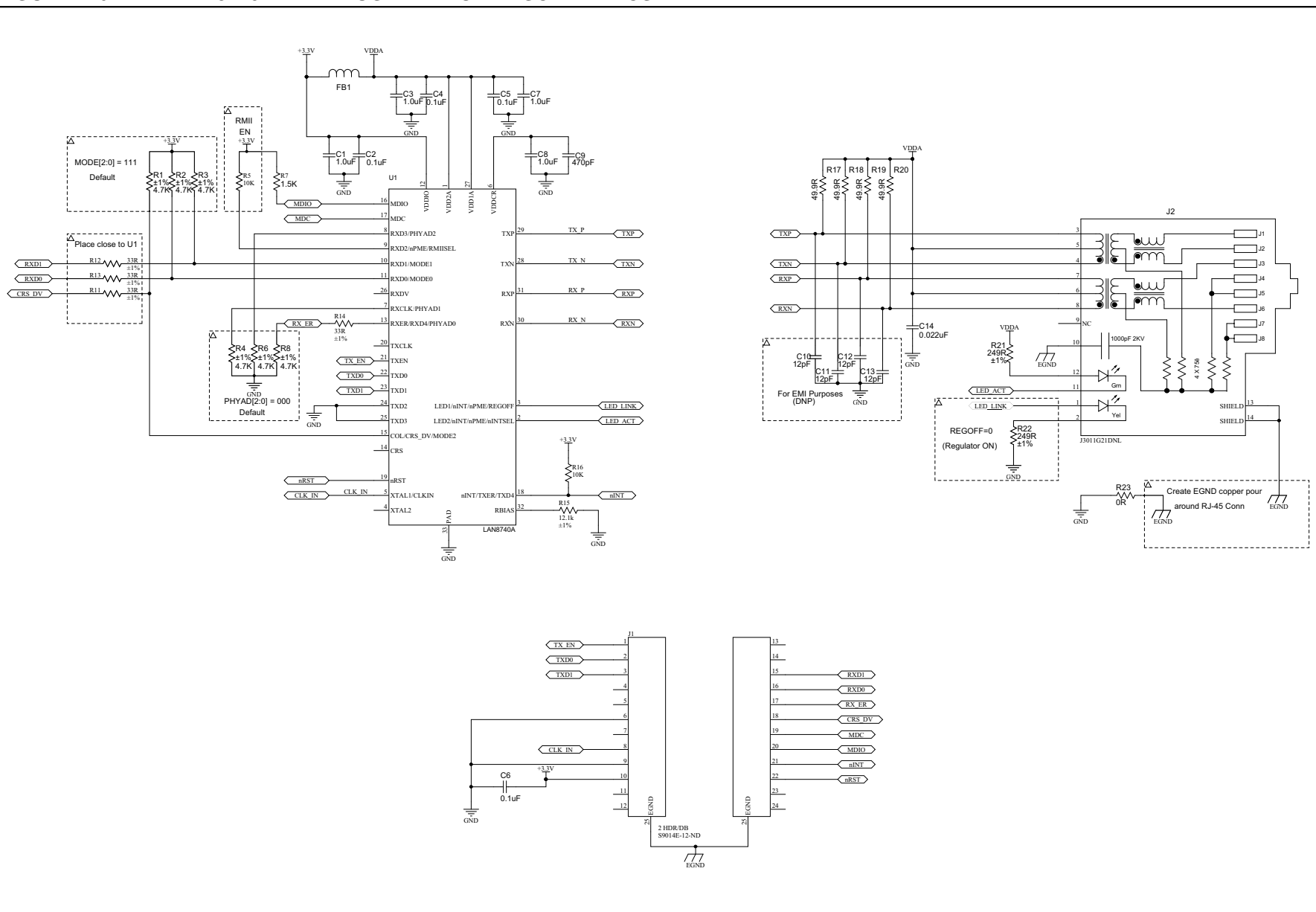| Reference	Description	Manufacturer	Part No.
C1, C2, C3, C4, C5, C6, C7, C8, C9, C10, C11, C12, C13, C14, C15, C16, C17, C18, C19	CAP CER .10 µF 50V X7R 0603	TDK Corporation	C1608X7R1H104M
C20, C21, C22, C23, C24, C25, C26, C27, C28, C29, C30, C48	CAP CER 10000 pF 50V X7R 0603	TDK Corporation	C1608X7R1H103M
C31, C32, C33	CAP CER 1.0 µF 16V X5R 10% 0603	TDK Corporation	C1608X5R1C105K
C38, C39	CAP CER 8 pF 50V NP0 0603	Murata	GRM1885C1H8R0DZ01D
C40, C41	CAP CER 2.2 µF 16V X5R 0603	TDK Corporation	C1608X5R1C225K
C42	CAP CER 4.7 µF 6.3V 10% X5R 0603	Taiyo Yuden	JMK107BJ475KA-T
C43, C44, C45	CAP CER 10 µF 16V Y5V 0805	Murata	GRM21BF51C106ZE15L
C46	CAP CER 100 µF 6.3V Y5V 1206	Murata	GRM31CF50J107ZE01L
D1, D2	DIODE SCHOTTKY 20V 0.5A SOD123	ON Semiconductor	MBR0520LT1G
D3	LED, SMD, RED, 0603 package	Kingbright Corp	APT1608EC
D4	LED, SMD, YEL, 0603 package	Kingbright Corp	APT1608YC
D5, D6, D7	LED, SMD, GRN, 0603 package	Kingbright Corp	APT1608SGC
J1	Hirose FX10_ 168-pin Header	Hirose Electric Co Ltd	FX10A-168P-SV1(71)
J7	CONN HEADER .050" 6 POS PCB GOLD	Samtec	TMS-106-01-G-S
J3	CONN RECEPT MINI USB 2.0 5 POS	Hirose Electric Co Ltd	UX60-MB-5ST
J4	CONN USB TYPE MICRO_A/B	Hirose Electric Co Ltd	ZX62-AB-5PA(11)
J5	CONN USB TYPE A R/A BLACK	On Shore Technology Inc	USB-A1HSB6
J6	12 POS 0.05" SINGLE ROW TH HEADER	Samtec	SLM-103-112-L-S
@ J6	3POS 0.05" SINGLE ROW TH HEADER	Samtec	SLM-103-103-L-S
JP2	2X2 (0.05"x 0.05") TH HEADER	Samtec	FTS-102-01-L-D
@ JP2	SHUNT 2POS (0.05" x 0.05")	SULLINS	NPB02DVFN-RC
JP1	CONN HEADER .100" SNGL STR 2POS	SULLINS	PRPC002SAAN-RC
Q1	TRANS SS PNP 40V 300MW SOT23	Micro Commercial Co.	MMBT3906-TP
Q2, Q3	TRANSISTOR NPN GP 40V SOT23	Micro Commercial Co.	MMBT3904-TP
Q5	MOSFET P-CH 8V 3.7A SOT23-3	ON Semiconductor	NTR2101PT1G
R1, R2, R3, R4	RES 4.7K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT4K70
R5, R6, R7, R8, R9, R10, R11, R12, R13	RES 330 OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT330R

Note   1:   Depending on the starter kit purchased, the development board will be populated with either a PIC32MZ2048ECM144 (w/Crypto Engine) device or a PIC32MZ2048ECH144 device.

TABLE B-1: PIC32MZ EMBEDDED CONNECTIVITY (EC) STARTER KIT BILL OF MATERIALS (CONTINUED)

Reference	Description	Manufacturer	Part No.
R14, R15, R16, R17, R18, R19, R20, R21, R22, R23	RES 10K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT10K0
R24, R25, R26, R27	RES 100K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT100K
R28, R29	RES 200K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT200K
R30, R31, R32	RES 2.21K OHM 1/10W 1% 0603 SMD	Panasonic - ECG	ERJ-3EKF2211V
R33	RES 3.92K OHM 1/10W 1% 0603 SMD	Yageo	RC0603FR-073K92L
R34	RES 1K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT1K00
R35	RES 100 OHM 1/10W 5% 0603 SMD	Yageo	RC0603JR-07100RL
R36	RES 100 OHM 1/4W 1% 1206 SMD	Yageo	RC1206FR-07100RL
R37	RES 3.16K OHM 1/10W 1% 0603 SMD	Yageo	RC0603FR-073K16L
R38, R39, R42, R55	RES 0.0 OHM 1/10W 0603 SMD	Rohm Semiconductor	MCR03EZPJ000
R48, R49, R50, R51, R52, R53	RES 33 OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc.	RMCF0603FT33R0
S1, S2, S3	Switch, Tact, PB MOM SMT, Series TL3302	C&K	PTS635SK25SMTR LFS
U1[1]	PIC32MZ2048ECH144-I/PH or PIC32MZ2048ECM144-I/PH	Microchip Technology Inc.	PIC32MZ2048ECH144-I/PH or PIC32MZ2048ECM144-I/PH
U2	IC PIC MCU FLASH 256K 64-TQFP	Microchip Technology Inc.	PIC24FJ256GB106-I/PT
U3	IC REG LDO 1.5A 3.3V 8DFN	Microchip Technology Inc.	MCP1727-3302E/MF
U4	IC EEPROM 256 KBIT 10 MHz 8TSSOP	Microchip Technology Inc.	25LC256-I/ST
U5	IC MULT CONFIG 3.3/5V .12A 8MSOP	Microchip Technology Inc.	MCP1253-33X50I/MS
U6	IC PWR DIST SWITCH SNGL SOT23-5	Texas Instruments	TPS2051BDBVR
U7	IC SWITCH LOAD FULL FUNC SOT23-5	Fairchild Semiconductor	FPF2104
U9	IC FLASH 32 MBIT 8-pin SOIC	Microchip Technology Inc.	SST26VF032-80-5I-S2AE
Y3	CRYSTAL 12.000000 MHZ 8 pF SMD	NDK	NX3225SA-12.000000MHZ
Y4	OSC MEMS 24.000 MHz SMD	Abracon Corporation	ASDMB-24.000MHZ-LC-T
Y5	OSC MEMS 50.000 MHz_1.8V ~3.3V SMD	Abracon Corporation	ASEMB-50.000MHZ-LC-T
+3.3V_PKOB, GND	PC TEST POINT MINIATURE SMT	Keystone Electronics	5015
bottom of board	BUMPON CYLINDRICAL .375X.135 BLK	3M	SJ61A8
Y1	CRYSTAL 24 MHz 8 pF SMD	AVX	CX3225GA24000D0PTVZ1
Y2	OSCILLATOR 32.768 kHz 3.3V SM	Abracon Corporation	TC25L5I32K7680
C34, C35	CAP CER 8 pF 50V NPO 0603	TDK Corporation	C1608C0G1H080D080AA
C36	CAP CER 10000 pF 50V X7R 0603	TDK Corporation	C1608X7R1H103M
R56	RES 1M OHM 1/8W 1% 0805 SMD	Vishay Dale	RMCF0805FT1M00

Note 1: Depending on the starter kit purchased, the development board will be populated with either a PIC32MZ2048ECM144 (w/Crypto Engine) device or a PIC32MZ2048ECH144 device.

B.2   LAN8740A PHY DAUGHTER BOARD BILL OF MATERIALS

TABLE B-2:   LAN8740A PHY DAUGHTER BOARD BILL OF MATERIALS

Reference	Description	Manufacturer	Part No.
C1, C3, C7, C8	Cap, Ceramic, 1 μF, 16V X5R	TDK Corporation	C1608X5R1C105K
C2, C4, C5, C6	Cap, Ceramic, 0.1 μF, 50V X7R	TDK Corporation	C1608X7R1H104M
C9	CAP 470 pF 50V CERAMIC X7R 0603	Yageo	CC0603KRX7R9BB471
C10, C11, C12, C13	CAP CER 12 pF 50V 5% NPO 0603	Yageo	CC0603JRNPO9BN120
C14	CAP CER 0.022 μF 50V 20% X7R 0603	Murata Electronics North America	GRM188R71H223MA01D
FB1	FERRITE CHIP 600 OHM 500MA 0805	TDK Corporation	MMZ2012Y601B
J1	TWO CONN HEADER .050" 12 POS PCB GOLD	Samtec	TMS-112-02-L-S
@J1	TWO CONN HEADER .050" 3 POS PCB GOLD	Samtec	TMS-103-02-L-S
J2	CONN MAGJACK 1PORT 100 BASE-TX	Pulse Electronics Corporation	J3011G21DNL
R1, R2, R3, R4, R6, R8	RES 4.70K OHM 1/10W 1% 0603 SMD	Panasonic - ECG	ERJ-3EKF4701V
R5, R16	RES 10K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc	RMCF0603FT10K0
R7	RES 1.50K OHM 1/10W 1% 0603 SMD	Vishay Dale	CRCW06031K50FKEA
R11, R12, R13, R14	RES 33 OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc	RMCF0603FT33R0
R15	RES 12.1K OHM 1/10W 1% 0603 SMD	Stackpole Electronics Inc	RMCF0603FT12K1
R17, R18, R19, R20	RES TF 1/10W 49.9 OHM 1% 0603	Stackpole Electronics Inc	RMCF0603FG49R9
R21, R22	RES TF 1/10W 249 OHM 1% 0603	Stackpole Electronics Inc	RMCF0603FG249R
R23	RES 0.0 OHM 1/4W 1206 SMD	Yageo	RC1206JR-070RL
U1	TX/RX ETHERNET 10/100 PHY Energy Efficient Ethernet and Wake-On-LAN	Microchip Technology Inc.	LAN8740A-EN

NOTES:

NOTES:

Worldwide Sales and Service

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200
Fax: 480-792-7277
Technical Support:
http://www.microchip.com/
support
Web Address:
www.microchip.com

Atlanta
Duluth, GA
Tel: 678-957-9614
Fax: 678-957-1455

Austin, TX
Tel: 512-257-3370

Boston
Westborough, MA
Tel: 774-760-0087
Fax: 774-760-0088

Chicago
Itasca, IL
Tel: 630-285-0071
Fax: 630-285-0075

Cleveland
Independence, OH
Tel: 216-447-0464
Fax: 216-447-0643

Dallas
Addison, TX
Tel: 972-818-7423
Fax: 972-818-2924

Detroit
Novi, MI
Tel: 248-848-4000

Houston, TX
Tel: 281-894-5983

Indianapolis
Noblesville, IN
Tel: 317-773-8323
Fax: 317-773-5453

Los Angeles
Mission Viejo, CA
Tel: 949-462-9523
Fax: 949-462-9608

New York, NY
Tel: 631-435-6000

San Jose, CA
Tel: 408-735-9110

Canada - Toronto
Tel: 905-673-0699
Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office
Suites 3707-14, 37th Floor
Tower 6, The Gateway
Harbour City, Kowloon

Hong Kong
Tel: 852-2943-5100
Fax: 852-2401-3431

Australia - Sydney
Tel: 61-2-9868-6733
Fax: 61-2-9868-6755

China - Beijing
Tel: 86-10-8569-7000
Fax: 86-10-8528-2104

China - Chengdu
Tel: 86-28-8665-5511
Fax: 86-28-8665-7889

China - Chongqing
Tel: 86-23-8980-9588
Fax: 86-23-8980-9500

China - Dongguan
Tel: 86-769-8702-9880

China - Hangzhou
Tel: 86-571-8792-8115
Fax: 86-571-8792-8116

China - Hong Kong SAR
Tel: 852-2943-5100
Fax: 852-2401-3431

China - Nanjing
Tel: 86-25-8473-2460
Fax: 86-25-8473-2470

China - Qingdao
Tel: 86-532-8502-7355
Fax: 86-532-8502-7205

China - Shanghai
Tel: 86-21-5407-5533
Fax: 86-21-5407-5066

China - Shenyang
Tel: 86-24-2334-2829
Fax: 86-24-2334-2393

China - Shenzhen
Tel: 86-755-8864-2200
Fax: 86-755-8203-1760

China - Wuhan
Tel: 86-27-5980-5300
Fax: 86-27-5980-5118

China - Xian
Tel: 86-29-8833-7252
Fax: 86-29-8833-7256

ASIA/PACIFIC

China - Xiamen
Tel: 86-592-2388138
Fax: 86-592-2388130

China - Zhuhai
Tel: 86-756-3210040
Fax: 86-756-3210049

India - Bangalore
Tel: 91-80-3090-4444
Fax: 91-80-3090-4123

India - New Delhi
Tel: 91-11-4160-8631
Fax: 91-11-4160-8632

India - Pune
Tel: 91-20-3019-1500

Japan - Osaka
Tel: 81-6-6152-7160
Fax: 81-6-6152-9310

Japan - Tokyo
Tel: 81-3-6880- 3770
Fax: 81-3-6880-3771

Korea - Daegu
Tel: 82-53-744-4301
Fax: 82-53-744-4302

Korea - Seoul
Tel: 82-2-554-7200
Fax: 82-2-558-5932 or
82-2-558-5934

Malaysia - Kuala Lumpur
Tel: 60-3-6201-9857
Fax: 60-3-6201-9859

Malaysia - Penang
Tel: 60-4-227-8870
Fax: 60-4-227-4068

Philippines - Manila
Tel: 63-2-634-9065
Fax: 63-2-634-9069

Singapore
Tel: 65-6334-8870
Fax: 65-6334-8850

Taiwan - Hsin Chu
Tel: 886-3-5778-366
Fax: 886-3-5770-955

Taiwan - Kaohsiung
Tel: 886-7-213-7828

Taiwan - Taipei
Tel: 886-2-2508-8600
Fax: 886-2-2508-0102

Thailand - Bangkok
Tel: 66-2-694-1351
Fax: 66-2-694-1350

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4450-2828
Fax: 45-4485-2829

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Dusseldorf
Tel: 49-2129-3766400

Germany - Karlsruhe
Tel: 49-721-625370

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Italy - Venice
Tel: 39-049-7625286

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Poland - Warsaw
Tel: 48-22-3325737

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

Sweden - Stockholm
Tel: 46-8-5090-4654

UK - Wokingham
Tel: 44-118-921-5800
Fax: 44-118-921-5820

07/14/15